SiHA5N80AE

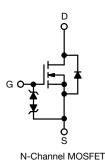
Vishay Siliconix

www.vishay.com

E Series Power MOSFET

Thin-Lead TO-220 FULLPAK





PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 1.17				
Q _g max. (nC)	16.5				
Q _{gs} (nC)	3				
Q _{gd} (nC)	6				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SiHA5N80AE-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	800	v	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current (T _J = 150 °C) $^{\circ}$	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		3.0		
	V _{GS} at 10 V	T _C = 100 °C		1.9	А	
Pulsed drain current ^a			I _{DM}	7	1	
Linear derating factor				0.5	W/°C	
Single pulse avalanche energy ^b			E _{AS}	17	mJ	
Maximum power dissipation			P _D	29	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	70	V/ns	
Reverse diode dv/dt ^d				0.3	v/ns	
Soldering recommendations (peak temperature) ^c For 10 s				260	°C	
Mounting torque, M3 screw		•		0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 1.1 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATINGS									
PARAMETER	SYMBOL	MAX.			UNIT				
Maximum junction-to-ambient	R _{thJA}	65			°C (M)				
Maximum junction-to-case (drain)	R _{thJC}			°C/W					
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)									
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT		
Static									
Drain-source breakdown voltage	V _{DS}	V _{GS} =	: 0 V, I _D = 250 μA	800	-	-	V		
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.8	-	V/°C		
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 250 \ \mu A$	2	-	4	V		
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 10			
Gate-source leakage	I _{GSS}	١	/ _{GS} = ± 30 V	-	-	± 50	μA		
		V _{DS} =	800 V, V _{GS} = 0 V	-	-	1			
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA		
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.5 A	-	1.17	1.35	Ω		
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D = 2 A	-	1.2	-	S		
Dynamic					•	•	•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	321	-	pF		
Output capacitance	C _{oss}			-	20	-			
Reverse transfer capacitance	C _{rss}			-	4	-			
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{\rm DS}$ = 0 V to 480 V, $V_{\rm GS}$ = 0 V		-	14	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	71	-			
Total gate charge	Qg			-	11	16.5			
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 2 \text{ A}, V_{DS} = 640 \text{ V}$		3	-	nC		
Gate-drain charge	Q _{gd}				6	-			
Turn-on delay time	t _{d(on)}			-	12	24			
Rise time	t _r	V_{DD} = 640 V, I_D = 2 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	8	16	- ns		
Turn-off delay time	t _{d(off)}			-	10	20			
Fall time	t _f			-	28	56			
Gate input resistance	R _g	f = 1 MHz, open drain		1.6	3.2	6.4	Ω		
Drain-Source Body Diode Characteristic	cs								
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.4			
Pulsed diode forward current	I _{SM}			-	-	7	A		
Diode forward voltage	V _{SD}	T _J = 25 °0	C, I _S = 2 A, V _{GS} = 0 V	-	-	1.2	V		
Reverse recovery time	t _{rr}			-	267	534	ns		
		T _J = 25 °C, I _F = I _S = 2 A, di/dt = 100 A/µs, V _B = 25 V							
Reverse recovery charge	Q _{rr}			-	1.2	2.4	μC		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

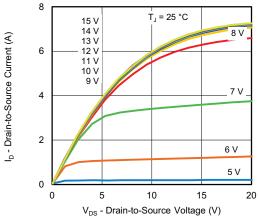


Fig. 1 - Typical Output Characteristics

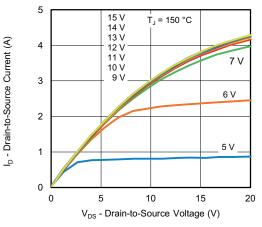


Fig. 2 - Typical Output Characteristics

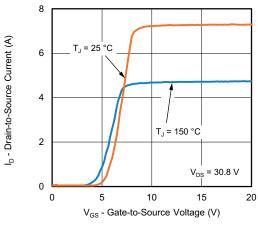


Fig. 3 - Typical Transfer Characteristics

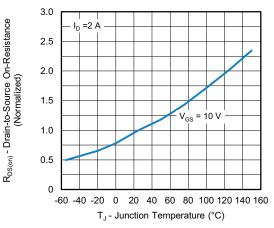


Fig. 4 - Normalized On-Resistance vs. Temperature

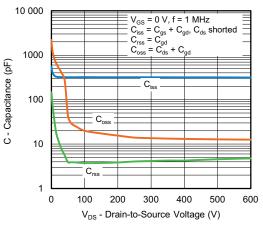
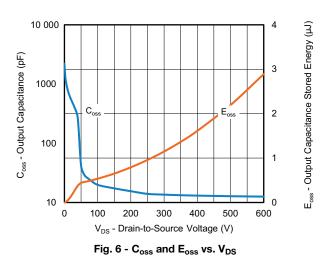


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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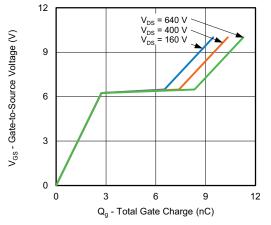


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

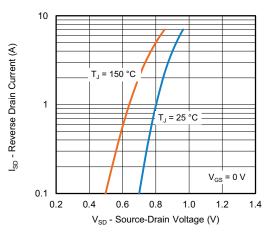


Fig. 8 - Typical Source-Drain Diode Forward Voltage

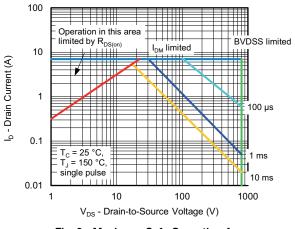


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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0 25 50 75 100 125 150 T_c - Case Temperature (°C) Fig. 11 - Normalized Breakdown Voltage vs. Temperature

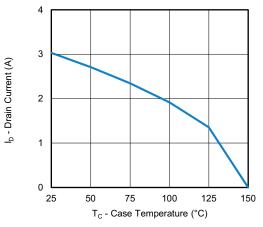
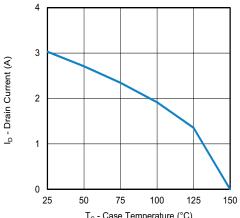


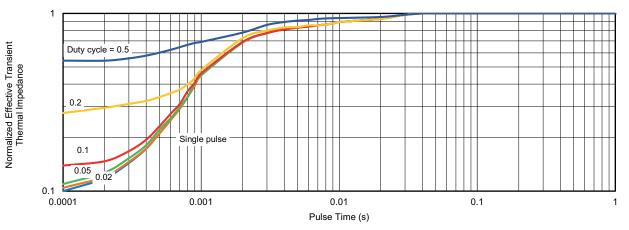
Fig. 10 - Maximum Drain Current vs. Case Temperature

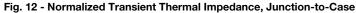


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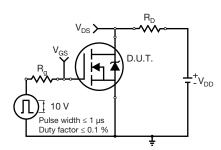


Fig. 13 - Switching Time Test Circuit

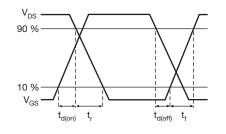


Fig. 14 - Switching Time Waveforms

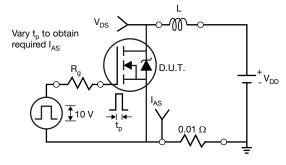


Fig. 15 - Unclamped Inductive Test Circuit

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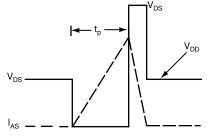


Fig. 16 - Unclamped Inductive Waveforms

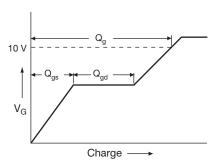
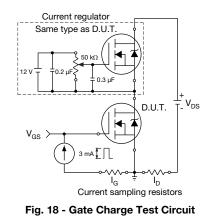


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dv/dt Test Circuit

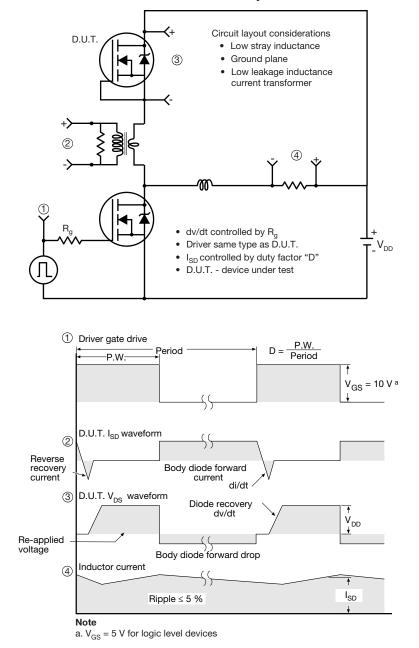


Fig. 19 - For N-Channel

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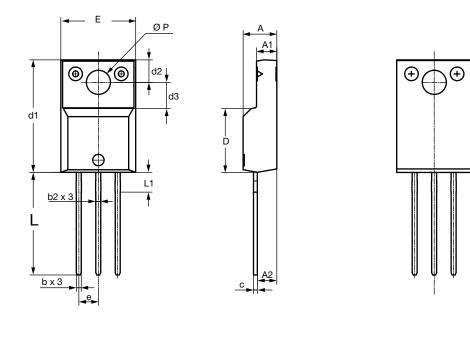
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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	•		

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